

# FAN256 — Dual Low Voltage Comparator

## Features

- Low Supply Current:  $I_{DD}=7\mu A$  (Typical)
- Single Power Supply Operation
- Wide Common-Mode Input Voltage Range: Rail-to-Rail
- Push-Pull Output Circuit
- Low Input Bias Current
- Internal Hysteresis
- Packaged in MicroPak™ 8 (1.6mm x 1.6mm)

## Applications

- Mobile Phones
- Alarm and Security Systems
- Personal Digital Assistants

## Description

The FAN256 is a low-power, dual comparator that typically consumes less than  $10\mu A$  supply current per comparator. Guaranteed to operate at a low voltage of 1.6V and fully operational up to 5.5V, it is convenient for use in 1.8, 3.0V, and 5.0V systems.

The FAN256 has a complementary push-pull P- and N-channel output stage capable of driving a rail-to-rail output swing with a load ranging up to 5.0mA.

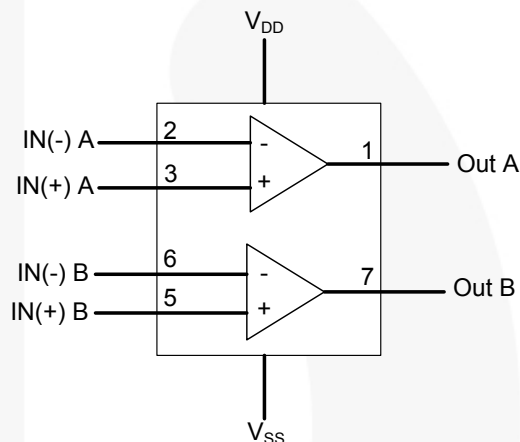


Figure 1. Functional Diagram

## Ordering Information

Part Number	Top Mark	Operating Temperature Range	Package	Packing Method
FAN256L8X	CP	-40 to 85°C	8-Lead, MicroPak™ 1.6mm x 1.6mm Package	5000 Units on Tape and Reel

### Pin Configuration

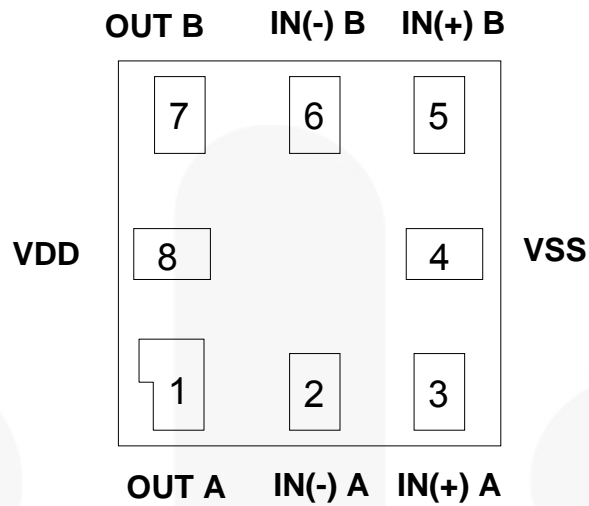


Figure 2. Pin Configuration (Top Through View)

### Pin Definitions

Pin #	Name	Description
1	OUT A	Comparator A Output
2	IN(-) A	Inverting Input of Comparator A
3	IN(+)' A	Non-Inverting Input of Comparator A
4	VSS	Negative Supply Voltage
5	IN(+)' B	Non-Inverting Input of Comparator B
6	IN(-) B	Inverting Input of Comparator B
7	OUT B	Comparator B Output
8	VDD	Positive Supply Voltage

### Function Table

Inputs	Outputs
$IN(-) > IN(+)$	Output LOW
$IN(+)' > IN(-)$	Output HIGH

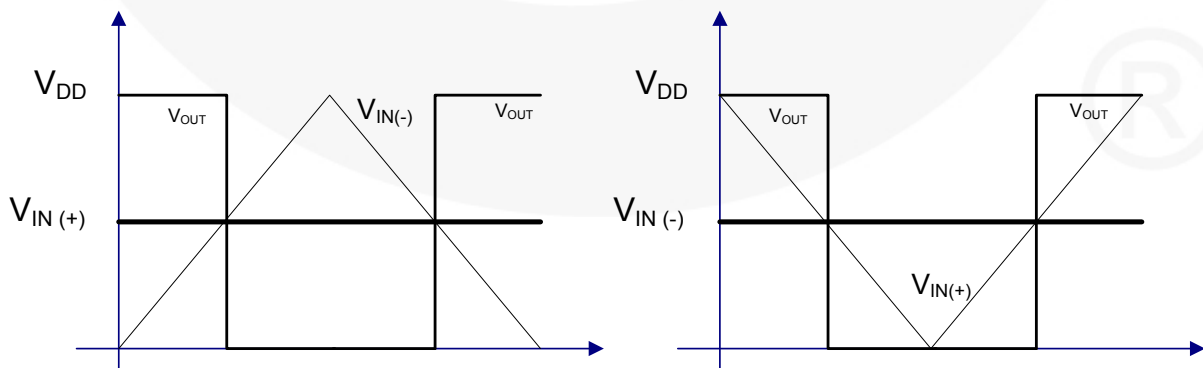


Figure 3.  $V_{IN}$  vs.  $V_{OUT}$

## Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter	Condition	Min.	Max.	Unit
$V_{DD}$ to $V_{SS}$	Supply Voltage		-3.0	+3.0	V
			0	6.0	
$DV_{IN}$	Differential Input Voltage			±6	
$V_{IN}$	Input Voltage			$V_{SS}$ to $V_{DD}$	V
$t_s$	Output Short Circuit Duration <sup>(1)</sup>			Indefinite	S
$T_J$	Junction Temperature			+150	°C
$T_{STG}$	Storage Temperature Range		-65	+150	°C
$P_D$	Power Dissipation			226	mW
$\Theta_{JA}$	Thermal Resistance			287	°C/W
ESD	IEC 61000-4-2 System ESD	Air Gap		15	kV
		Contact		8	
	JEDEC JESD22-A114, Human Body Model	All Pins		8	
		Pin to Pin: IN(-), IN(+) to $V_{DD}$ or $V_{SS}$		12	
JEDEC JESD22-C101, Charged Device Model	All Pins		2		

### Note:

- The maximum total power dissipation must not be exceeded.

## Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to Absolute Maximum Ratings.

Symbol	Parameter	Condition	Min.	Max.	Unit
$V_{DD}$ to $V_{SS}$	Power Supply		-2.75	+2.75	V
			0	5.5	
$V_{DD}$	Power Supply	$V_{SS}=0V$	1.6	5.5	V
$V_{IN}$	Input Voltage			$V_{SS}$ to $V_{DD}$	V
$I_{OH}/I_{OL}$	Output Sink/Source Current	$V_{DD}=5.0V$		5	mA
		$V_{DD}=3.0V$		3	
		$V_{DD}=1.6V$		1	
$T_A$	Operating Temperature, Free Air		-40	+85	°C

## Electrical Characteristics

Symbol	Parameter	Condition	Min.	Typ.	Max.	Unit
<b>V<sub>DD</sub>=5.5V, V<sub>SS</sub>=GND, and T<sub>A</sub>=+25°C</b>						
V <sub>HYS</sub>	Input Hysteresis	V <sub>CM</sub> =0.5V <sub>DD</sub>		4		mV
V <sub>IO</sub>	Input Offset Voltage <sup>(2)</sup>	V <sub>CM</sub> =0.5V <sub>DD</sub>	-15	±1	+15	mV
I <sub>IO</sub>	Input Offset Current			10		pA
I <sub>I</sub>	Input Bias Current			10		pA
V <sub>CM</sub>	Common Mode Input Voltage		V <sub>SS</sub>		V <sub>DD</sub>	V
CMRR	Common Mode Rejection Ratio <sup>(3)</sup>	V <sub>CM</sub> =V <sub>DD</sub>		68		dB
I <sub>DD</sub>	Supply Current - Per Comparator			7	17	µA
PSRR	Power Supply Rejection Ratio <sup>(3)</sup>	ΔV <sub>DD</sub> =0.5V	45	80		dB
I <sub>OS</sub>	Output Short Circuit Current	V <sub>O</sub> =V <sub>DD</sub>		60		mA
		V <sub>O</sub> =V <sub>SS</sub>		90		
V <sub>OL</sub>	Low-Level Output Voltage	I <sub>SINK</sub> =5.0mA		0.1	0.3	V
V <sub>OH</sub>	High-Level Output Voltage	I <sub>SOURCE</sub> =5.0mA	5.2	5.4		V
t <sub>PLH</sub>	Propagation Delay (Turn-On)	Overdrive=20mV, C <sub>L</sub> =15pF		0.40		µs
t <sub>PHL</sub>	Propagation Delay (Turn-Off)	Overdrive=20mV, C <sub>L</sub> =15pF		0.42		µs
t <sub>TLH</sub>	Response Time, Output Rise/Fall <sup>(4)</sup>	C <sub>L</sub> =50pF		4.0		ns
t <sub>THL</sub>				5.4		
<b>V<sub>DD</sub>=3V, V<sub>SS</sub>=GND, and T<sub>A</sub>=+25°C</b>						
V <sub>HYS</sub>	Input Hysteresis	V <sub>CM</sub> =0.5V <sub>DD</sub>		4		mV
V <sub>IO</sub>	Input Offset Voltage <sup>(2)</sup>	V <sub>CM</sub> =0.5V <sub>DD</sub>	-15	±1	+15	mV
I <sub>IO</sub>	Input Offset Current			10		pA
I <sub>I</sub>	Input Bias Current			10		pA
V <sub>CM</sub>	Common Mode Input Voltage		V <sub>SS</sub>		V <sub>DD</sub>	V
CMRR	Common Mode Rejection Ratio <sup>(3)</sup>	V <sub>CM</sub> =V <sub>DD</sub>		60		dB
I <sub>DD</sub>	Supply Current(x) Per Comparator			6	15	µA
PSRR	Power Supply Rejection Ratio <sup>(3)</sup>	ΔV <sub>DD</sub> =0.5V	45	70		dB
I <sub>OS</sub>	Output Short Circuit Current	V <sub>O</sub> =V <sub>DD</sub>		27		mA
		V <sub>O</sub> =V <sub>SS</sub>		35		
V <sub>OL</sub>	Low-Level Output Voltage	I <sub>SINK</sub> =3.0mA		0.15	0.35	V
V <sub>OH</sub>	High-Level Output Voltage	I <sub>SOURCE</sub> =3.0mA	2.65	2.85		V
t <sub>PLH</sub>	Propagation Delay (Turn-On)	Overdrive=20mV, C <sub>L</sub> =15pF		0.45		µs
t <sub>PHL</sub>	Propagation Delay (Turn-Off)	Overdrive=20mV, C <sub>L</sub> =15pF		0.47		µs
t <sub>TLH</sub>	Response Time, Output Rise/Fall <sup>(4)</sup>	C <sub>L</sub> =50pF		6.1		ns
t <sub>THL</sub>				6.2		

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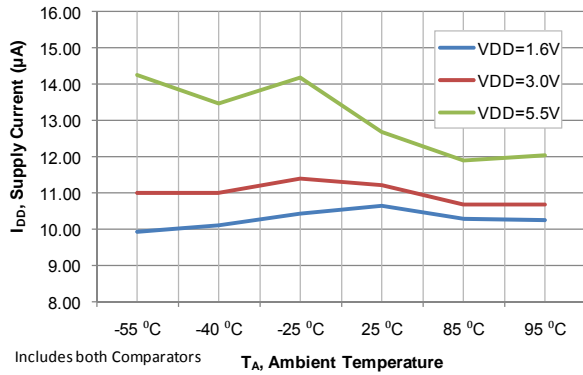
## Electrical Characteristics

Symbol	Parameter	Condition	Min.	Typ.	Max.	Unit
<b>V<sub>DD</sub>=1.6V, V<sub>SS</sub>=GND, and T<sub>A</sub>=+25°C</b>						
V <sub>HYS</sub>	Input Hysteresis	V <sub>CM</sub> =0.5V <sub>DD</sub>		3.5		mV
V <sub>IO</sub>	Input Offset Voltage <sup>(2)</sup>	V <sub>CM</sub> =0.5V <sub>DD</sub>	-15	±1	+15	mV
I <sub>IO</sub>	Input Offset Current			10		pA
I <sub>I</sub>	Input Bias Current			10		pA
V <sub>CM</sub>	Common Mode Input Voltage		V <sub>SS</sub>		V <sub>DD</sub>	V
CMRR	Common Mode Rejection Ratio <sup>(3)</sup>	V <sub>CM</sub> =V <sub>DD</sub>		56		dB
I <sub>DD</sub>	Supply Current(x) Per Comparator			5	13	µA
PSRR	Power Supply Rejection Ratio <sup>(3)</sup>	ΔV <sub>DD</sub> =0.5V	45	70		dB
I <sub>OS</sub>	Output Short Circuit Current	V <sub>O</sub> =V <sub>DD</sub>		5.5		mA
		V <sub>O</sub> =V <sub>SS</sub>		7.5		
V <sub>OL</sub>	Low-Level Output Voltage	I <sub>SINK</sub> =1.0mA		0.15	0.25	V
V <sub>OH</sub>	High-Level Output Voltage	I <sub>SOURCE</sub> =1.0mA	1.35	1.50		V
t <sub>PLH</sub>	Propagation Delay (Turn-On)	Overdrive=20mV, C <sub>L</sub> =15pF		0.52		µs
t <sub>PHL</sub>	Propagation Delay (Turn-Off)	Overdrive=20mV, C <sub>L</sub> =15pF		0.54		µs
t <sub>TLH</sub>	Response Time, Output Rise/Fall <sup>(4)</sup>	C <sub>L</sub> =50pF		16.5		ns
t <sub>THL</sub>				13.0		

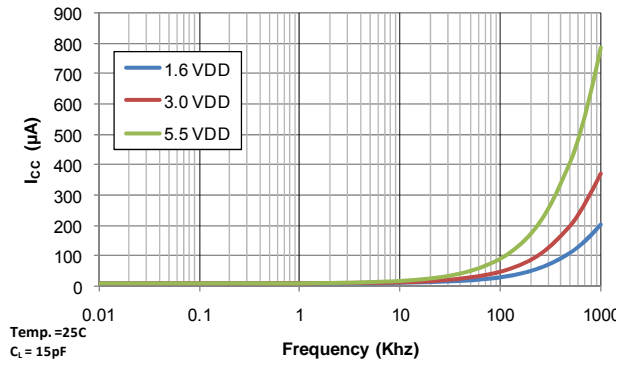
**Notes:**

- Differential input switching level is guaranteed at the minimum or maximum offset voltage, minus or plus half the maximum hysteresis voltage.
- Guaranteed by design and characterization data
- Input signal: 1kHz, square-wave signal with 10ns edge rate.

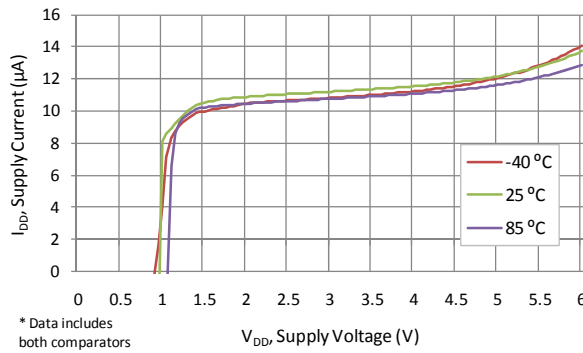
## Typical Performance Characteristics



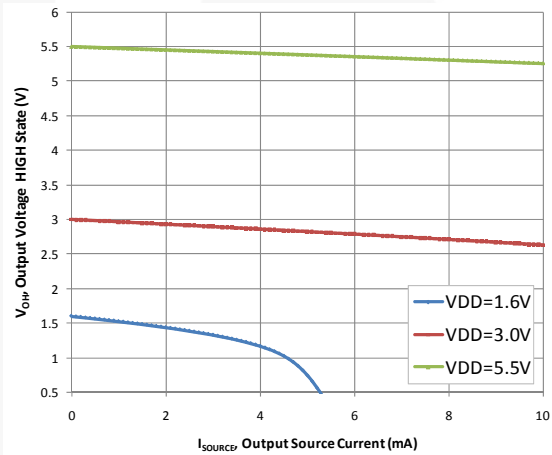
**Figure 4. Supply Current vs. Temperature**



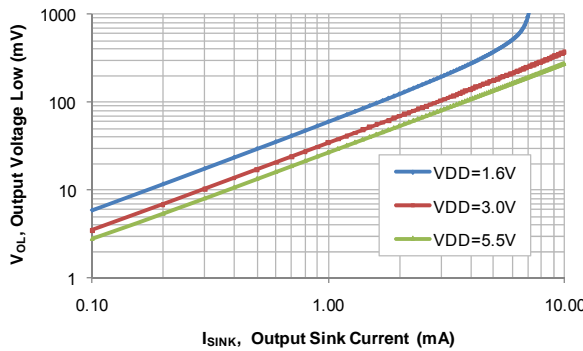
**Figure 5. Supply Current vs. Output Transition Frequency**



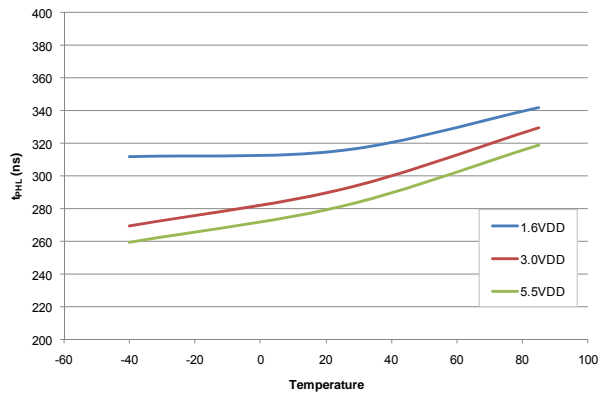
**Figure 6. Supply Current vs. Supply Voltage**



**Figure 7. Output HIGH vs. Output Drive Current**



**Figure 8. Output LOW vs. Output Drive Current**



**Figure 9. Propagation Delay (t<sub>PHL</sub>) vs. Temperature**

Typical Performance Characteristics (Continued)

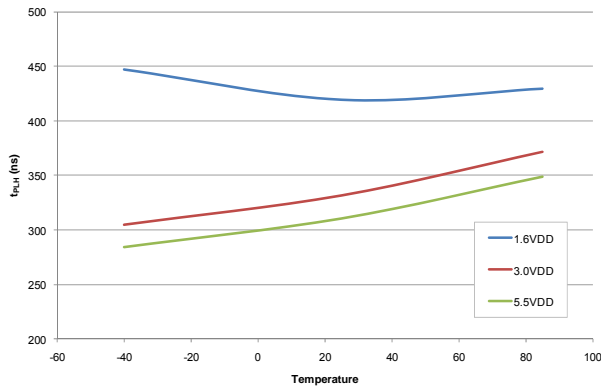


Figure 10. Propagation Delay ( $t_{PLH}$ ) vs. Temperature

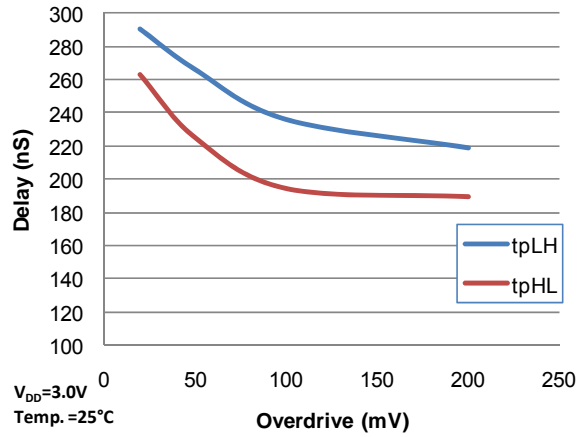


Figure 11. Propagation Delay vs. Input Overdrive

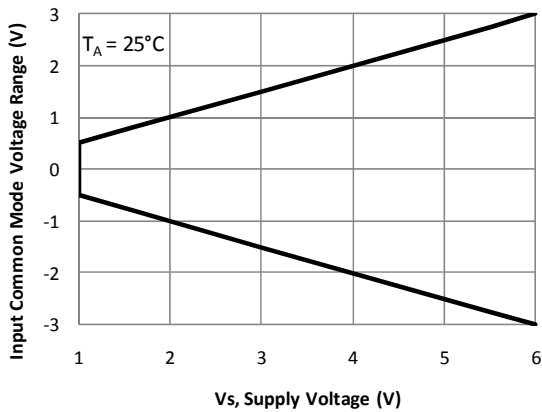


Figure 12. Input Common Mode Voltage Range vs. Supply Voltage

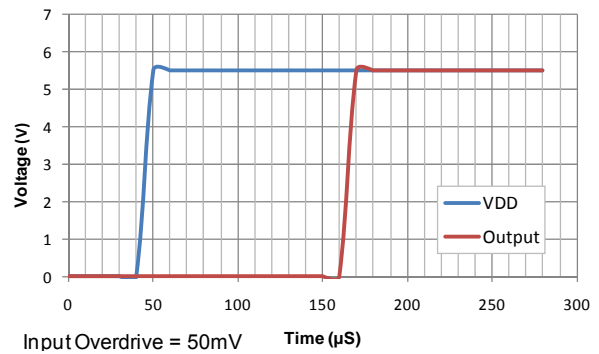
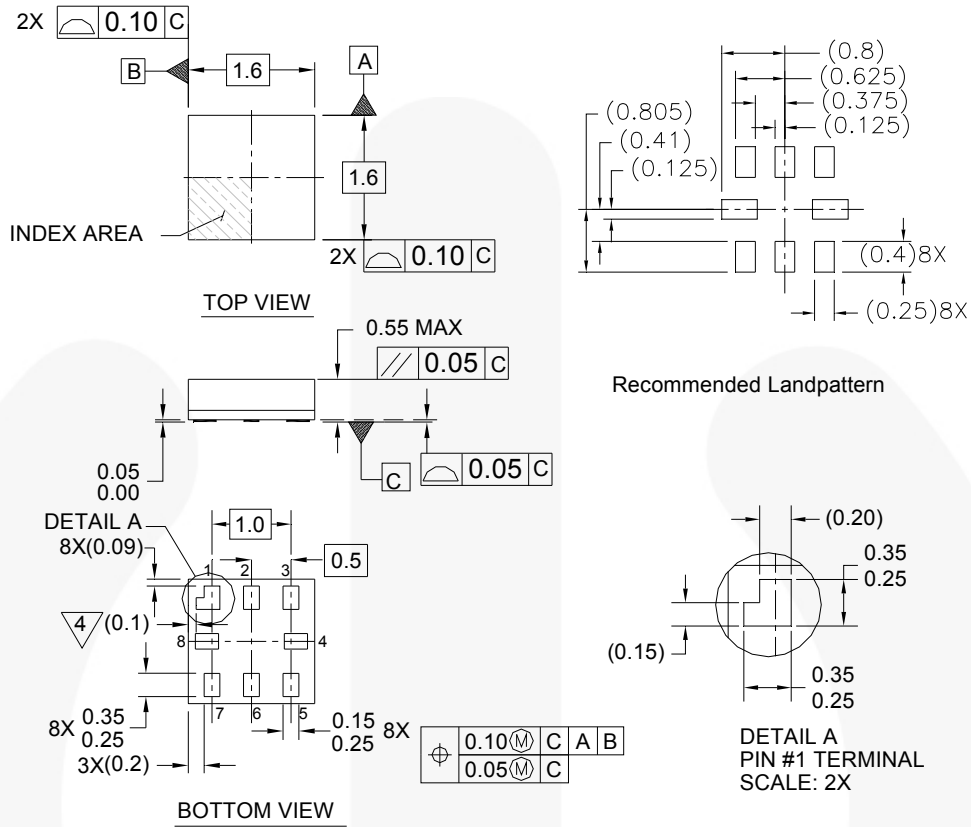


Figure 13. Power-Up Delay

## Physical Dimensions



### Notes:

1. PACKAGE CONFORMS TO JEDEC MO-255 VARIATION UAAD
2. DIMENSIONS ARE IN MILLIMETERS
3. DRAWING CONFORMS TO ASME Y.14M-1994
4. PIN 1 FLAG, END OF PACKAGE OFFSET
5. DRAWING FILE NAME: MKT-MAC08AREV4

MAC08AREV4

**Figure 14. 8-Lead, MicroPak™ 1.6mm Wide**

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## Tape and Reel Specifications




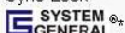

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